## What is claimed is:

1. A hotmelt adhesive composition for the coating and/or lamination of sheetlike structures in accordance with the double dot technique, wherein upper dot is based on an amine-terminated crosslinkable copolyamide and the lower dot is composed of an OH-terminated polyester and further comprises a crosslinker and an acrylic and/or PU dispersion.

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- 2. A hotmelt adhesive composition as claimed in claim 1, wherein the upper dot is an amine-regulated copolyamide.
- 3. A hotmelt adhesive composition as claimed in either of the preceding claims, wherein the upper dot is an amine-regulated copolyamide powder having a melting range of from 90 to 150°C and a solution viscosity eta rel in the range from 1.2 to 1.7.

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- 4. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein the lower dot is an OH-terminated copolyester.
- 25 5. A hotmelt adhesive composition as claimed in claim 1, wherein the lower dot comprises an acrylate dispersion and/or polyurethane dispersion.
- 6. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein the crosslinking component comes from the group of the isocyanates and has more than two reactive groups per molecule.
- 7. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein the isocyanate has a melting range of from 100 to 130°C.
  - 8. A hotmelt adhesive composition as claimed in any of

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the preceding claims, wherein an epoxide having a melting range of from 90 to 130°C, a molecular weight range of from 2 000 to 6 000 and more than two epoxide groups per molecule is employed as crosslinking component.

- 9. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein a pulverulent free or blocked isocyanate is employed as crosslinking component.
- 10. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein the crosslinking component is an epichlorohydrin.
- 11. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein the reactive, OH-terminated copolyester is employed as base dot for the double dot technology, as a strikethrough barrier.
- 12. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein the base dot consists of a passivated isocyanate and an OH-terminated copolyester and is applied in halftone formation as a paste.
- 13. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein the crosslinking reaction is accelerated by catalysts.
- 14. A hotmelt adhesive composition as claimed in any of the preceding claims, wherein the copolyester is based on terephthalic acid and/or isophthalic acid and/or adipic acid and/or dodecanedioic acid and on butanediol and/or hexanediol and/or polyglycol and/or PTHF.
  - 15. The use of a hotmelt adhesive composition as claimed in any of the preceding claims for the coating and/or lamination of sheetlike structures.

16. An interlining material for clothing, which has been provided with a hotmelt adhesive composition as claimed in any of the preceding claims.